

High Capacitance Capacitors

■ HOW TO ORDER

1206	F	106 Z 100		100	С	Т
<u>Size</u>	<u>Dielectric</u>	<u>Capacitance</u>	<u>Tolerance</u>	Rated voltage	<u>Termination</u>	<u>Packaging</u>
Inch (mm) 0402 (1005) 0603 (1608) 0805 (2012) 1206 (3216) 1210 (3225) 1812 (4532)	B=X7R X=X5R S=X6S F=Y5V	Two significant digits followed by no. of zeros. And R is in place of decimal point. eg.: 106=10x10° =10µF	K=±10% M=±20% Z=-20/+80%	Two significant digits followed by no. of zeros. And R is in place of decimal point. 6R3=6.3 VDC 100=10 VDC 160=16 VDC 250=25 VDC 500=50 VDC	C=Cu/Ni/Sn	B=Bulk C=Bulk cassette T=7" reeled G=13" reeled

■ PACKAGING DIMENSION AND QUANTITY

6:	This law and (many) (Com	ale al	Pape	r tape	Plasti	c tape	
Size	Thickness (mm)/Syn	nbol	7" reel	13" reel	7" reel	13" reel	
0402 (1005)	0.50±0.05	N	10k	50k	-	-	
0/02/1/00	0.80±0.07	S	4k	15k	-	-	
0603 (1608)	0.80+0.15/-0.10	Х	4k	15k	-	-	
	0.80±0.10	В	4k	15k	-	-	
0805 (2012)	1.25±0.10	D	-	-	3k	10k	
	1.25±0.20	1	-	-	3k	10k	
	0.95±0.10	С	-	-	3k	10k	
1207 (2217)	1.15±0.15	J	-	-	3k	10k	
1206 (3216)	1.60±0.20	G	-	-	2k	-	
	1.60+0.30/-0.10	Р	-	-	2k	-	
	0.95±0.10	С	-	-	3k	10k	
1010 (2025)	1.25±0.10	D	-	-	3k	10k	
1210 (3225)	1.60±0.20	G	-	-	2k	-	
	2.00±0.20	К	-	-	1k	-	
1012 (4522)	1.25±0.10	D	-	-	1k	-	
1812 (4532)	2.00±0.20	K	-	-	1k	-	

Unit: pieces



High Capacitance Capacitors

■ CAPACITANCE RANGE

X7R Dielectric

	Dielectric	X7R															
	Size	0402	0603				0805		1206				1210		1812		
Rat	ted Voltage (VDC)	10	10	16	25	50	10	16	25	10	16	25	50	25	50	25	50
	0.10µF (104)	N		S	S	Х											
	0.15µF (154)		S	S													
	0.22µF (224)		S	S													
gy.	0.33µF (334)		Χ	Х													
an C	0.47µF (474)		Χ	X													
gcit.	0.68µF (684)																
Capacitance	1.0µF (105)		Χ				D	D	D		J	J	Р	D	D	D	K
O	1.5µF (155)																
	2.2µF (225)									J	J	Р		G			
	3.3µF (335)									Р							
	4.7μF (475)									Р							

- 1. The letter in cell is expressed the symbol of product thickness.
- 2. For more information about products with special capacitance or other data, please contact WTC local representative.

X5R Dielectric

	Dielectric					Х	(5R					
	Size		0402			0603		0805	1206			
Rat	ed Voltage (VDC)	6.3 10 16		6.3	10 16		6.3	6.3	10	16		
	0.027µF (273)			N								
	0.033µF (333)			N								
	0.039µF (393)			N								
	0.047µF (473)			N								
	0.056µF (563)		N	N								
	0.068µF (683)		N	N								
	0.082µF (823)		N	N								
	0.10µF (104)		N	N								
<u>ഉ</u>	0.15µF (154)											
İar	0.22µF (224)	N*										
Capacitance	0.33µF (334)					Х	Х					
l g	0.47µF (474)					X	Х					
	0.68µF (684)				Х	Х	Х					
	1.0µF (105)				Х	Х						
	1.5µF (155)										J	
	2.2µF (225)							I		J	J	
	3.3µF (335)									Р	Р	
	4.7μF (475)							I		Р	Р	
	6.8µF (685)								Р	Р		
	10μF (106)							I	Р	Р		

- The letter in cell is expressed the symbol of product thickness.
 The letter in cell with "*" mark is expressed product also available for X6S dielectric.
 The shadow cell is expressed that product is under development, please contact WTC local representative to inquire more information.

Y5V Dielectric

	Dielectric										Y5V								
	Size	04	02	0603 0805			1206			1210				1812					
Rat	ted Voltage (VDC)	6.3	10	10	16	10	16	25	10	16	25	50	10	16	25	35	50	25	50
	0.15µF (154)		N																
	0.22µF (224)		N																
	0.33µF (334)	N																	
	0.47µF (474)	N																	
	0.68µF (684)	N																	
Capacitance	1.0µF (105)	Ν		S	Х	В	В	D		С	С	С					С		D
<u>i</u> zi	1.5µF (155)			S		D	D			С	С				С				D
g	2.2µF (225)			S		D	D			С	С				С				D
<u>B</u>	3.3µF (335)					D	D		J	J	J				С				D
	4.7µF (475)					D	D		J	J	J			С	D				D
	6.8µF (685)					I			J	J				С	G				D
	10μF (106)					- 1			J	J				D	G	K		D	
	22µF (226)								Р				K						
	47μF (476)												K						

- 1. The letter in cell is expressed the symbol of product thickness.
- 2. For more information about products with special capacitance or other data, please contact WTC local representative.



Appendix I: Reliability Test Conditions and Requirements

NO.	Item		Test Condition	Requirements							
1.	Visual and Mechanical				No remar Dimensio			individu	al specification sheet.		
2.	Capacitance	Class I : NPO		* Shall not exceed the limits given in the detailed spec.							
3.	Q/ D.F. (Dissipation Factor)		±0.2Vrms, 1MHz±10% ±0.2Vrms, 1KHz±10%		NPO: Cap X7R, X5R		1000;	Cap<30	OpF, Q 400+20C		
		Class II : X7R, X5R	Y5V		Rated vol	. D.F.	Excep	otion of			
		Cap 10μF, 1.0±0.2Vrms, 1KHz±10% Cap>10μF, 0.5±0.2Vrms, 120Hz±20%			50V	2.5%	3.0%) I	201;0603 0.047μF;0805 0.18μF; 0 0.47μF		
					25V	3.5%	5.0%	0805	5 1μF, 1210 10μF		
							7.0%	0402	3 0.33μF;TT series & Cap 1μF 2 0.033μF;0603 0.15μF;		
					16V	3.5%	5.0%	0805	5 0.68μF;1206 2.2μF		
					10% 10V 5.0% 10.09				ries & Cap 1µF ries & Cap 1µF;0805 10µF		
					6.3V	10.0%			i 22μF;1210 100μF		
					Y5V:						
					Rated vol).F. .0%	Excepti	ion of D.F.		
					35V		.0%				
					251/	-	00/	7.0%	0603 0.1μF; 0805 0.33μF;		
					25V	٥	.0%	9.0%	1206 1μF; 1210 4.7μF 0402 0.068μF		
					16V (C<1		.0%	9.0%	0402 0.068µF; 0603 0.68µF		
					16V (C 1		.0% 2.5%	12.5%	0805 4.7μF;1206 10μF;1210 22μF		
					6.3V		0.0%				
4a.	Dielectric Strength	* To apply voltage	(50V) 250%.	*	No evider	nce of da	mage o	r flash o	ver during test.		
		* Duration : 1 to 5 sec. * Charge & discharge current less than 50mA.							-		
	•										
		* To apply voltage 100V	3 times V DC								
		200V ~ 300V	2 times V DC								
		500V ~ 999V 1000V ~ 3000V	1.5 times V DC 1.2 times V DC								
		* Cut-off, set at 1	0mA								
		* TEST= 15 sec. * RAMP=0									
4b.	Dielectric Strength	* To apply 1500 V	'AC voltage.	*	No evider	nce of da	mage o	r flash o	ver during test.		
.2.	(for X1/Y2 & X2/Y3)		0		110 01140.	100 O. GG	ago o		voi dumig tooti		
5.	Insulation	To apply rated vol	tage for max. 120 sec.		10G or f	RxC 500	-F whi	chever i	s smaller.		
	Resistance	Rated voltage:	To apply rated voltage for 60 sec.		10G						
		100 ~ 500V									
		Rated voltage: > 500V	To apply 500V for 60 sec.		10G						
6.	Temperature	With no electrical	load								
0.	Coefficient	T.C.	Operating Temp	[T.C.	C	apacita	nce Cha	nge		
		NPO (COG)	-55~125°C at 25°C		NPO (CO	G) V	Vithin ±	30ppm/	°C		
		NPO (COJ) X7R	-55~125°C at 25°C -55~125°C at 25°C] }	NPO (CO. X7R		Vithin ± Vithin ±	120ppm	n/°C		
		X5R	-55~85°C at 25°C] }	X5R		Vithin ±				
		Y5V	-25~85°C at 20°C		Y5V	V	Vithin +	30%/-80	0%		
7.	Adhesive Strength	* Pressurizing force	e:	*	No remar	kable da	mage or	remova	al of the terminations.		
	of Termination	0201: 2N					0				
		0402 & 0603: 5 >0603: 10N	IN								
		* Test time: 10±1	sec.								
8.	Vibration	* Vibration freque	ency: 10~55 Hz/min.	*	No remar	kable da	mage.				
	Resistance	* Total amplitude:	1.5mm				0	o meet i	nitial spec.		
			(Two hrs each in three adicular directions.)								
		21 12.	,								



Appendix I: Reliability Test Conditions and Requirements

NO.	Item	Test Condition	Requirements				
9.	Solderability	* Solder temperature: 235±5°C * Dipping time: 2±0.5 sec.	95% min. coverage of all metalized area.				
10.	Bending Test	* The middle part of substrate shall be pressurized by means of the pressurizing rod at a rate of about 1 mm per second until the deflection becomes 1 mm and then the pressure shall be maintained for 5±1 sec. * Measurement to be made after keeping at room temp. for 24±2 hrs.	* No remarkable damage. * Cap change: NPO: within ±5.0% or ±0.5pF whichever is larger. X7R, X5R: within ±12.5% Y5V: within ±30% (This capacitance change means the change of capacitance under specified flexure of substrate from the capacitance measured before the test.)				
11.	Resistance to Soldering Heat	* Solder temperature: 270±5°C * Dipping time: 10±1 sec * Preheating: 120 to 150°C for 1 minute before immerse the capacitor in an eutectic solder. * Before initial measurement (Class II only): Perform 150+0/-10°C for 1 hr and then set for 48±4 hrs at room temp. * Measurement to be made after keeping at room temp. for 24±2 hrs. (Class I) or 48±4 hrs. (Class II).	* No remarkable damage. * Cap change: NP0: within ±2.5% or ±0.25pF whichever is larger. X7R, X5R: within ±7.5% Y5V: within ±20% * Q/D.F., I.R. and dielectric strength: To meet initial requirements. * 25% max. leaching on each edge.				
12.	Temperature Cycle	* Conduct the five cycles according to the temperatures and time. Step Temp. (°C) Time (min.) 1 Min. operating temp. +0/-3 30±3 2 Room temp. 2~3 3 Max. operating temp. +3/-0 30±3 4 Room temp. 2~3 * Before initial measurement (Class II only): Perform 150+0/-10°C for 1 hr and then set for 48±4 hrs at room temp. * Measurement to be made after keeping at room temp. for 24±2 hrs. (Class I) or 48±4 hrs. (Class II).	* No remarkable damage. * Cap change: NPO: within ±2.5% or ±0.25pF whichever is larger. X7R, X5R: within ±7.5% Y5V: within ±20% * Q/D.F., I.R. and dielectric strength: To meet initial requirements.				
13.	Humidity (Steady State)	* Test temp.: 40±2°C * Humidity: 90~95% RH * Test time: 500+24/-0hrs. * Measurement to be made after keeping at room temp. for 24±2 hrs. (Class I) or 48±4 hrs. (Class II).	* No remarkable damage. * Cap change: NPO: within ±5.0% or ±0.5pF whichever is larger. X7R, X5R: 10V, within ±12.5% 6.3V, within ±25% Y5V: within ±30% * Q/D.F. value: NPO: Cap 30pF, Q 350; 10pF Cap<30pF, Q 275+2.5C Cap<10pF; Q 200+10C X7R, X5R: Rated vol. D.E. Exception of D.F. 50V 3.0% 6.0% 0603 0.047µF; 0805 0.18µF; 1206 0.47µF 25V 5.0% 10.0% 0805 1µF, 1210 10µF 14.0% 0603 0.33µF 16V 5.0% 10.0% 0402 0.033µF; 0603 0.15µF; 0805 0.68µF; 1206 2.2µF 10V 7.5% 15.0% 0805 2.2µF; 1206 2.2µF, TT series & Cap 1µF 6.3V 15.0% 30.0% 0805 10µF; 1210 100µF Y5V: Rated vol. D.F. Exception of D.F. 50V 7.5% 35V 10.0% 10.0% 0603 0.1µF; 0805 0.33µF; 1206 1µF; 1210 4.7µF 12.5% 0402 0.068µF 16V (C<1.0µF) 10.0% 12.5% 0402 0.068µF 16V (C 1.0µF) 12.5% 10V 15.0%				



Appendix I: Reliability Test Conditions and Requirements

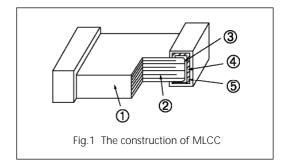
NO.	Item	Test Condition	Requirements
14.	Humidity Load (Damp Heat)	* Test temp.: 40±2°C * Humidity: 90~95%RH * Test time: 500+24/-0 hrs. * To apply voltage: rated voltage (Max. 500V) * Measurement to be made after keeping at room temp. for 24±2 hrs. (Class I) or 48±4 hrs. (Class II).	* No remarkable damage. * Cap change: NP0: within ±7.5% or ±0.75pF whichever is larger. X7R, X5R: 10V, within ±12.5% 6.3V, with ±25% Y5V: 10V, within ±30% 6.3V, within ±30 to -40% * Q/D.F. value: NP0: Cap 30pF, Q 200; Cap<30pF, Q 100+10/3C
			X7R, X5R: Rated vol. D.F. Exception of D.F.
			Rated vol. D.F. Exception of D.F. 50V 7.5%
15.	High Temperature Load (Endurance)	* Test temp.: NPO, X7R: 125±3°C X5R, Y5V: 85±3°C * To apply voltage: (1) 6.3V or C 10µF (for X7R, X5R): 150% of rated voltage. (2) 6.3V <v<500v (3)="" (4)="" (class="" (for="" (max.="" *="" -0="" 1000+24="" 120%="" 150%="" 200%="" 24±2="" 3600v)="" 48±4="" 500v:="" 630v:="" after="" and="" at="" be="" c<10µf="" for="" hrs.="" i)="" ii).<="" keeping="" made="" measurement="" of="" or="" rated="" room="" temp.="" test="" th="" time:="" to="" v="" voltage.="" x5r):="" x7r,=""><th>* No remarkable damage. * Cap change: NPO: within ±3.0% or ±0.3pF whichever is larger. X7R, X5R: 10V, within ±12.5% 6.3V, with ±25% Y5V: 10V, within ±30% 6.3V, within ±30 to -40% * Q/D.F. value: NPO: Cap 30pF, Q 350 10pF Cap<30pF, Q 275+2.5C Cap<10pF, Q 200+10C X7R, X5R: Rated vol. D.F. Exception of D.F. 50V 3.0% 6.0% 0603 0.047µF; 0805 0.18µF, 1206 0.47µF 25V 5.0% 10.0% 0805 1µF, 1210 10µF 14.0% 0603 0.33µF 16V 5.0% 10.0% 0805 0.68µF; 1206 2.2µF 10V 7.5% 15.0% 0805 2.2µF; 1206 2.2µF TT series & Cap 1µF</th></v<500v>	* No remarkable damage. * Cap change: NPO: within ±3.0% or ±0.3pF whichever is larger. X7R, X5R: 10V, within ±12.5% 6.3V, with ±25% Y5V: 10V, within ±30% 6.3V, within ±30 to -40% * Q/D.F. value: NPO: Cap 30pF, Q 350 10pF Cap<30pF, Q 275+2.5C Cap<10pF, Q 200+10C X7R, X5R: Rated vol. D.F. Exception of D.F. 50V 3.0% 6.0% 0603 0.047µF; 0805 0.18µF, 1206 0.47µF 25V 5.0% 10.0% 0805 1µF, 1210 10µF 14.0% 0603 0.33µF 16V 5.0% 10.0% 0805 0.68µF; 1206 2.2µF 10V 7.5% 15.0% 0805 2.2µF; 1206 2.2µF TT series & Cap 1µF
			11 Series & Cap TµF



Appendix II: General Information

Constructions

No.	Na	me	NPO/X7R	X7R/X5R/Y5V			
1	Ceramic	material	BaTiO₃ based				
2	Inner el	ectrode	AgPd alloy	Ni			
3		Inner layer	Ag	Cu			
4	Termination	Middle layer	ı	Ji			
5		Outer layer	Sn (N	Matt)			



Storage and handling conditions

- (1) To store products at 5 to 40°C ambient temperature and 20 to 70%. related humidity conditions.
- (2) The product is recommended to be used within one year after shipment. Check solderability in case of shelf life extension is needed.

Cautions:

- a. Don't store products in a corrosive environment such as sulfide, chloride gas, or acid. It may cause oxidization of electrode, which easily be resulted in poor soldering.
- b. To store products on the shelf and avoid exposure to moisture.
- c. Don't expose products to excessive shock, vibration, direct sunlight and so on.

Recommended soldering conditions

The lead-free termination MLCCs are not only to be used on SMT against lead-free solder paste, but also suitable against lead-containing solder paste. If the optimized solder joint is requested, increasing soldering time, temperature and concentration of N₂ within oven are recommended.

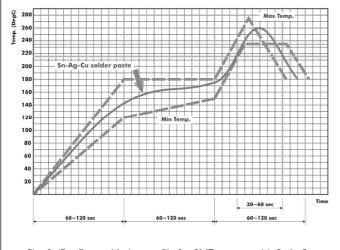


Fig. 2 IR reflow soldering profile for SMT process with SnAgCu series solder paste.

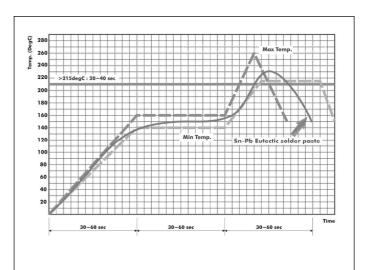


Fig. 3 IR reflow soldering profile for SMT process with eutectic SnPb solder paste.